

**WSF45P06** 

P-Ch MOSFET

## **General Description**

The WSF45P06 is the highest performance trench P-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF45P06 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

## **Product Summery**

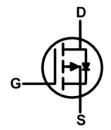
BVDSS	RDSON	ID
-60V	40mΩ	-45A

## Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- CCFL Back-light Inverter

### **TO-252 Pin Configuration**





## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	-60	V	
V <sub>GS</sub>	Gate-Source Voltage	±20	V	
I₀@T₀=25℃	Continuous Drain Current, -V <sub>GS</sub> @ -10V <sup>1</sup>	-45	А	
I <sub>D</sub> @T <sub>C</sub> =100℃	Continuous Drain Current, -V <sub>GS</sub> @ -10V <sup>1</sup>	-38	А	
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	-90	А	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	66	mJ	
I <sub>AS</sub>	Avalanche Current	-27.2	А	
P₀@T₀=25℃	Total Power Dissipation <sup>4</sup>	31.3	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 15		°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>eJA</sub>	Thermal Resistance Junction-Ambient <sup>1</sup> 62		62	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		4	°C/W



**P-Ch MOSFET** 

## P-Channel Electrical Characteristics (T\_J=25 $\ ^{\circ}\!\!\!\!C$ , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-60			V
$\triangle BV_{DSS} / \triangle T_J$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$ , I_D=-1mA		-0.012		V/℃
Proven	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V , I <sub>D</sub> =-18A		30	40	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-12A		52	65	1115.2
V <sub>GS(th)</sub>	Gate Threshold Voltage		-1.0	-1.6	-2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS, ID2300A		4.32		mV/℃
IDSS	Drain-Source Leakage Current	$V_{\text{DS}}\text{=-32V}$ , $V_{\text{GS}}\text{=}0\text{V}$ , $T_{\text{J}}\text{=}25^\circ\!\mathrm{C}$			1	- uA
DSS	Drain-Source Leakage Current	$V_{DS}$ =-32V , $V_{GS}$ =0V , TJ=55 $^{\circ}$ C			5	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm20V$ , $V_{DS}$ = $0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-18A		12.6		S
R <sub>g</sub>	Gate Resistance	$V_{DS}$ =0V , $V_{GS}$ =0V , f=1MHz		13	16	Ω
Qg	Total Gate Charge (-4.5V)			4.1		
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =-20V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-12A		4.9		nC
Q <sub>gd</sub>	Gate-Drain Charge			5.6		
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =-15V , V <sub>GS</sub> =-10V , R <sub>G</sub> =3.3Ω, I <sub>D</sub> =-1A		19.2		
Tr	Rise Time			12.8		20
T <sub>d(off)</sub>	Turn-Off Delay Time			48.6		ns
T <sub>f</sub>	Fall Time			4.6		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		1914		
Coss	Output Capacitance			158		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			116		

### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy $^5$	V <sub>DD</sub> =-25V , L=0.1mH , I <sub>AS</sub> =-15A	20			mJ

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,6</sup>	$V_G = V_D = 0V$ , Force Current			-23	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>				-46	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25℃			-1	V

Note :

<sup>1.</sup> The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.

<sup>2.</sup>The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

<sup>3.</sup> The EAS data shows Max. rating . The test condition is  $V_{DD}$ =-25V,  $V_{GS}$ =-10V, L=0.1mH,  $I_{AS}$ =-20A

<sup>4.</sup>The power dissipation is limited by 150  $^\circ\!\!\!{\rm C}$  junction temperature

<sup>5.</sup> The Min. value is 100% EAS tested guarantee.

<sup>6.</sup> The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



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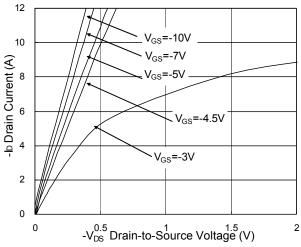


Fig.1 Typical Output Characteristics

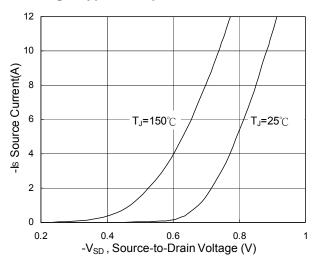
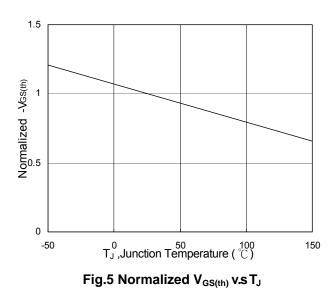


Fig.3 Forward Characteristics of Reverse



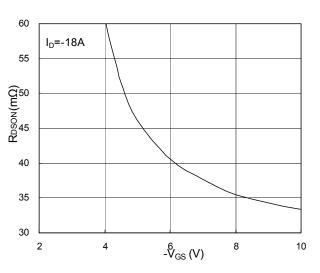


Fig.2 On-Resistance v.s Gate-Source

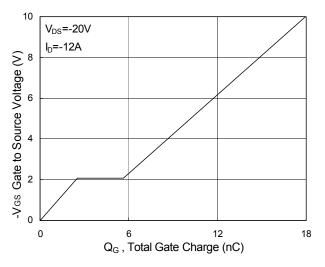


Fig.4 Gate-Charge Characteristics

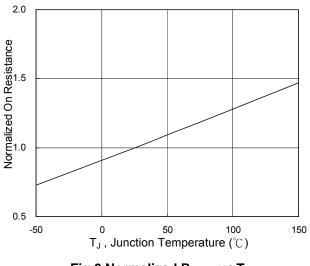
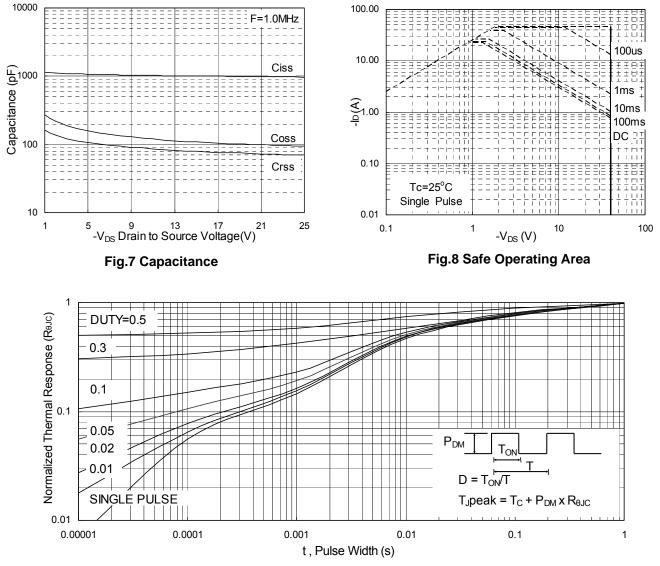


Fig.6 Normalized R<sub>DSON</sub> v.s T<sub>J</sub>

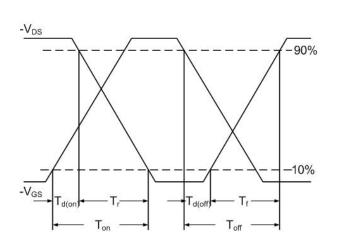


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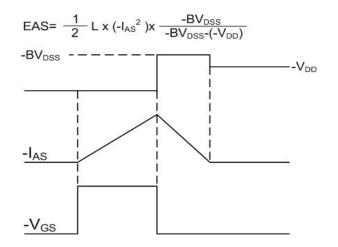
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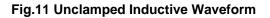














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